

Laser polishing in the field of SRF cavities

Super Surfer project meeting in Wuppertal

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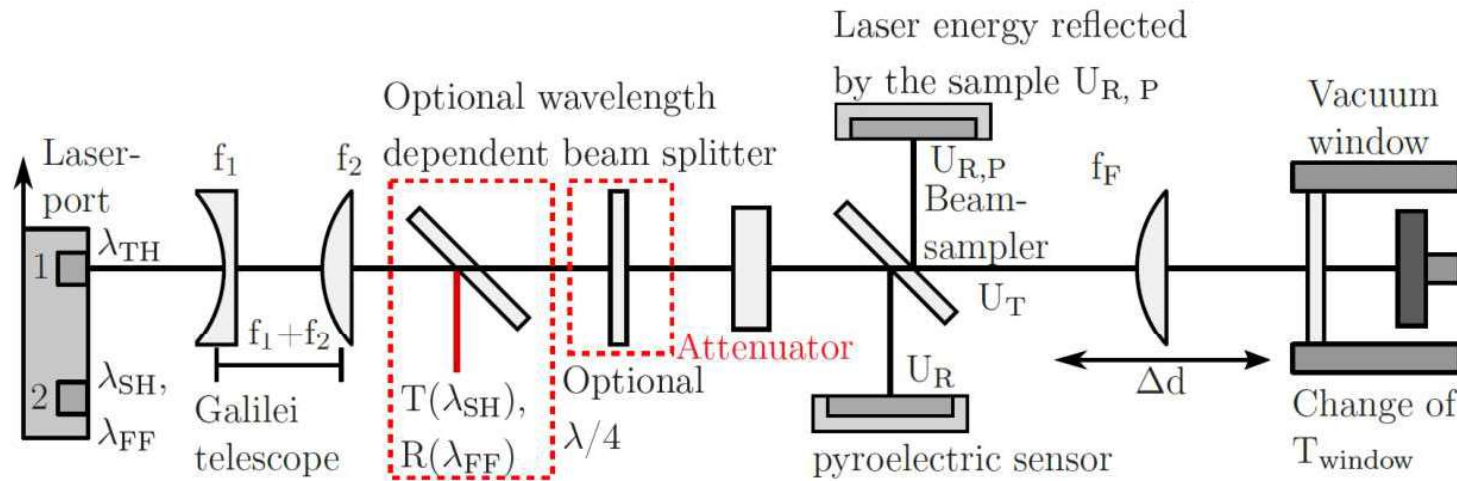


Project plan

Project plan

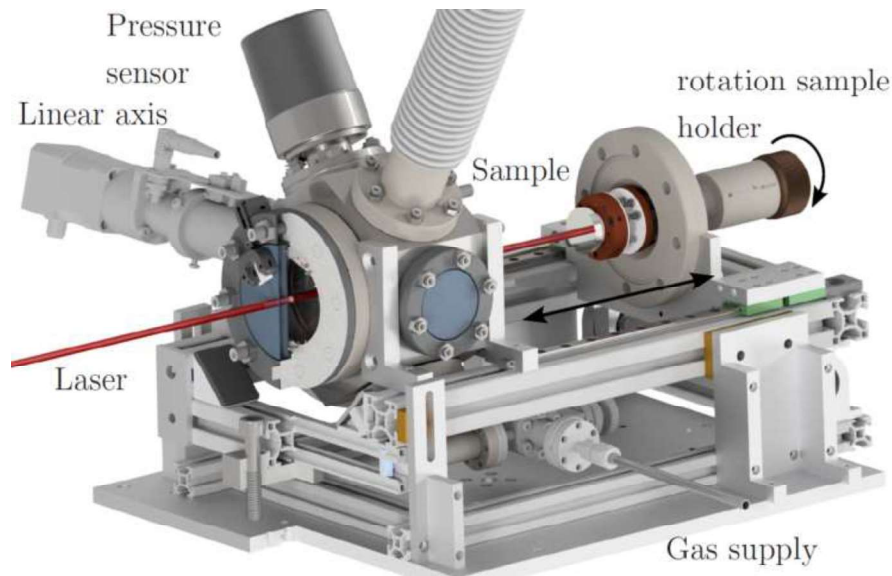
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Experimental setup for laser polishing BUW

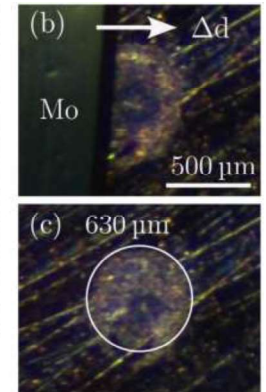
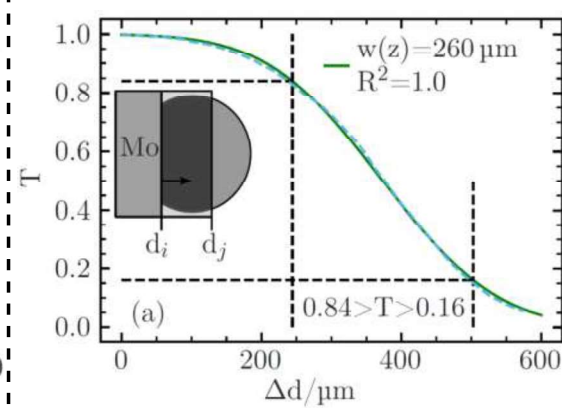
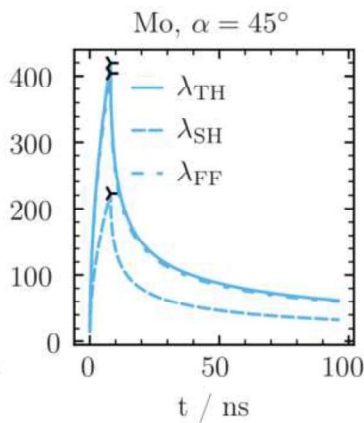
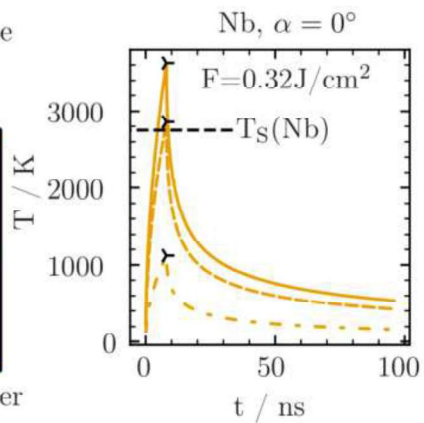
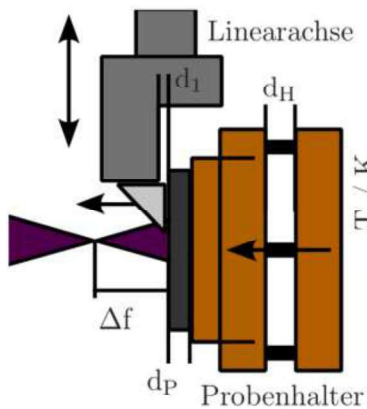


- **Telescope:** Change of laser diameter, d
- **Beamsampler:** Energy measurement, $U_{R,P}$, U_R
- **Focus lens (ΔA) / Beam attenuator (ΔU)**
Change of $F=U/A$
- **$U_{R,P}/U_R$:** Influence of the transmission of the window + change in the reflectivity of the sample + Influence of surface waviness
⇒ Changes observable as a result of the LP
- **Pressure measurement:** ΔP Indication of the modification of the surface
- **Electrical signals:** Charge emission as a result of the laser pulse
- **Beam profile camera:** Measurement of the beam profile
⇒ better alignment, more precise determination of F
- **Long-range microscope:** Insitu inspection of surface modification
- **Beam shaper:** Convert Gaussian profile to top hat profile

Vacuum chamber

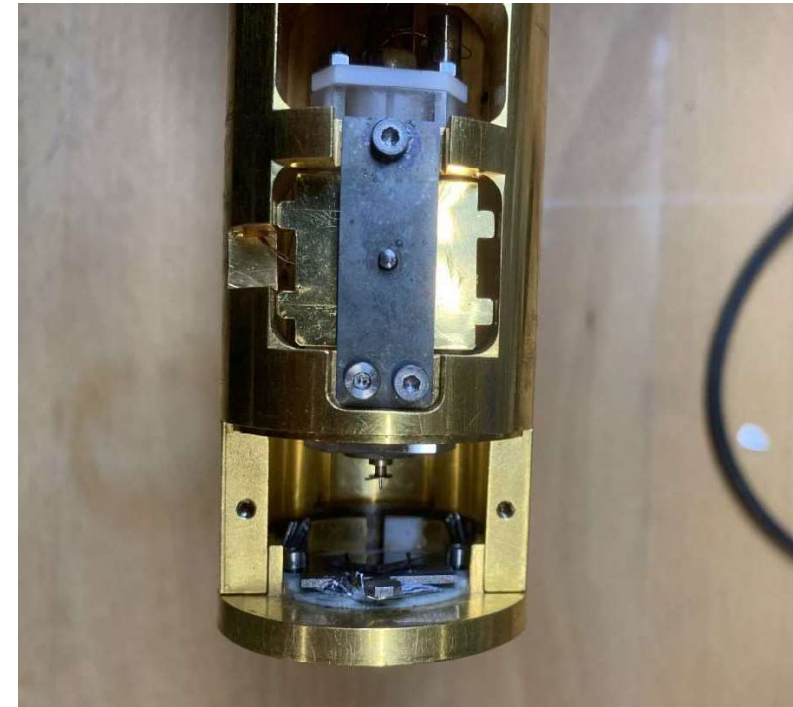
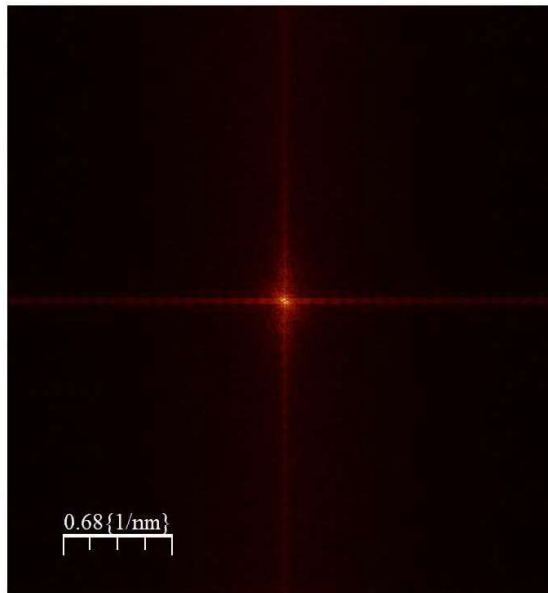
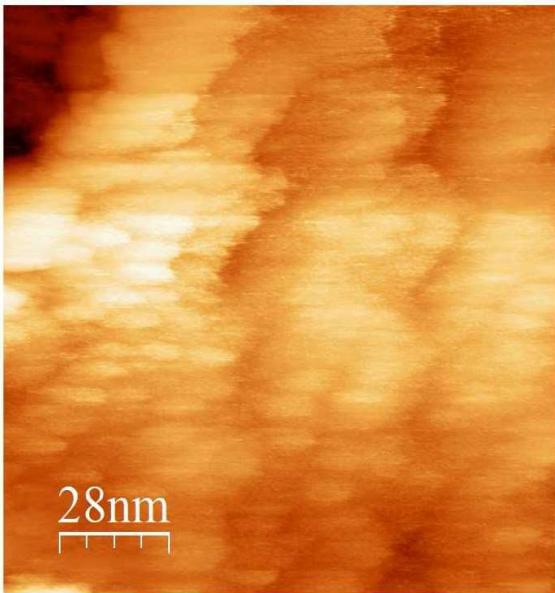


- Extension of the vacuum chamber by a movable cutting edge to determine the beam diameter at the sample surface
- Beam diameter unclear $\Rightarrow$ so far only possible indirectly by measuring the damage by SEM or optical microscope
- Selection of the material of the cutting edge with analytical solution of the heat conduction equation, W, Ta, Mo
- Measurement shows discrepancy between beam diameter and size of surface damage



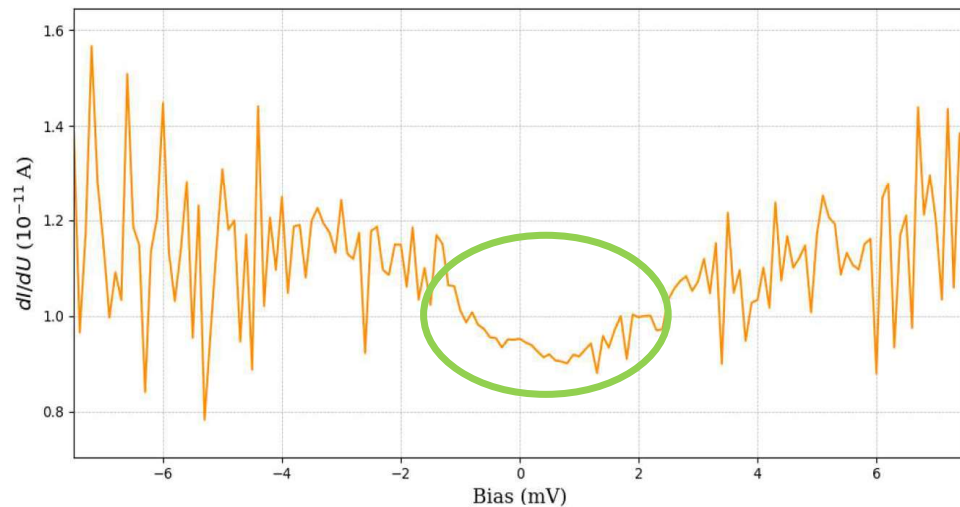
First results of the STM measurements

- Large grain, (110)-oriented Nb-samples, standard DESY treatment, mirror-like polish
- Dip-stick STM, temperatures down to 4 K with LHe-cooling ($\Delta E \approx 1.5 - 1.8$ meV)
- Topography + tunneling spectroscopy (at low T, i.e. 4 – 7 K)



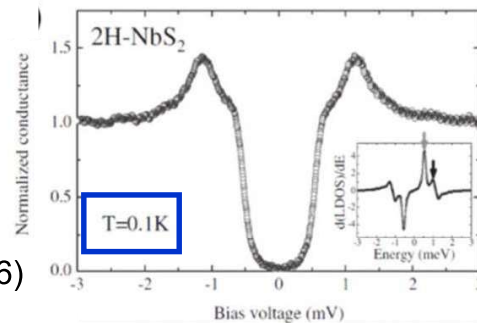
⇒ no atomic resolution at 4 K. FT does not provide (periodic) interatomic distances

- Tunneling spectroscopy ($T = 4.7$ K):



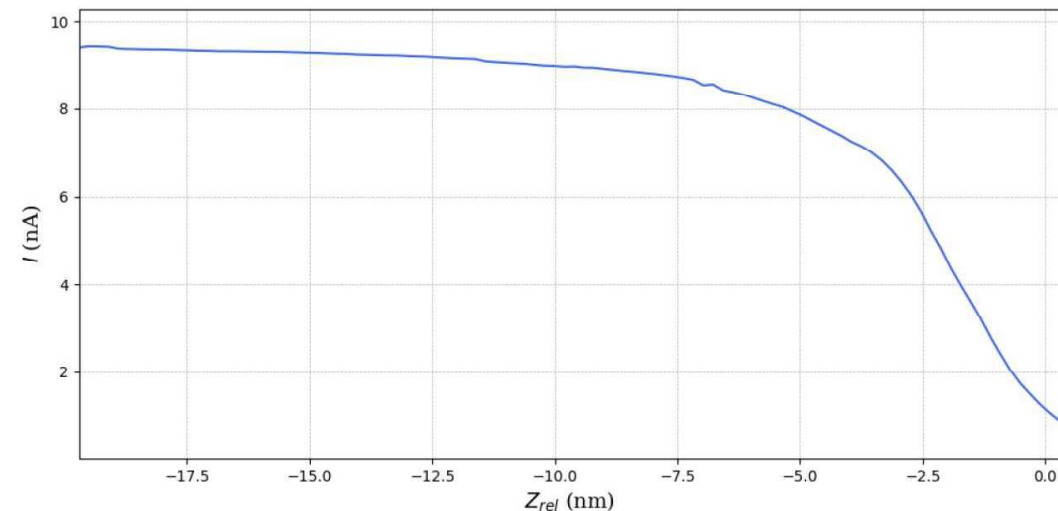
⇒ No indications for superconducting gap (Nb: $E_g \approx 2.3$ meV)

(Quantum Frontiers 3 (2024) 6)



Compare Sci. Rep. 10 (2020) 3794

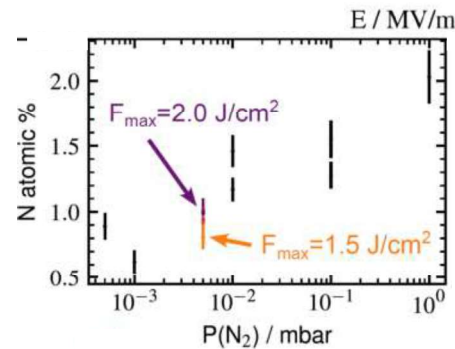
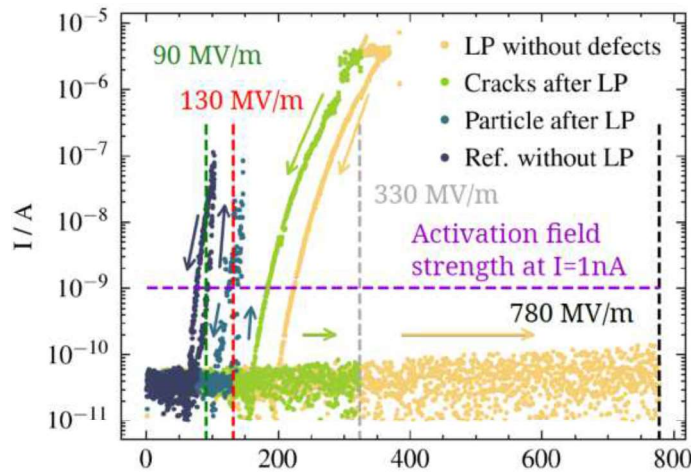
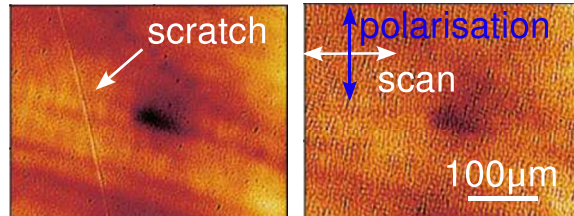
- Z-spectroscopy ($T = 4.7$ K): Variation of tunneling distance (z) below the working point ($z=0$)



- ⇒ Exponential increase of tunneling current down to $z=-2.5$ nm
- ⇒ Then saturation *below* I_{max} (10 nA): Point contact with high resistance.
- ⇒ Influence of oxide layer (passive layer) on Nb due to contact with air?

BSc. Thesis T. Köster, Wuppertal (2025)

**Laser material treatment of
copper wafers with Nb₃Sn layers
(HZB)**



Previously: Examination of Nb

- Polishing (macro / micro)
- Suppression of field emission
- Oxide removal
- Nitrogen incorporation
- Recrystallization

⇒ from bulk to thin-film

Laser material processing

Near-surface treatment

⇒ Depth approx. < 2 µm (depending on the process parameters)

⇒ Positive influences on thin films

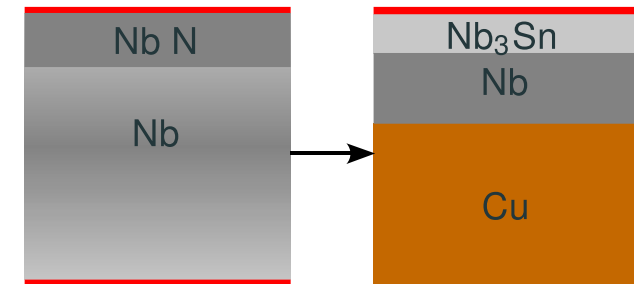
⇒ Polishing (?) Remelting (?) Crystal growth (?)

Laser material processing of alloys very challenging

Nb₃Sn ⇒ Material parameters differ greatly

In the future

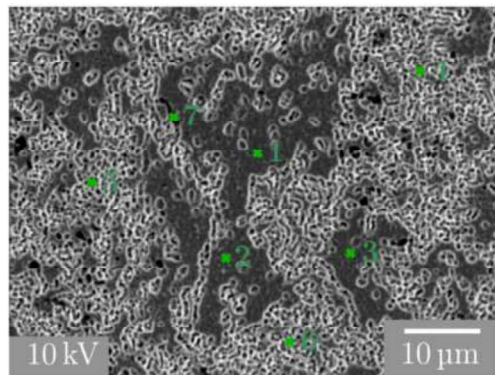
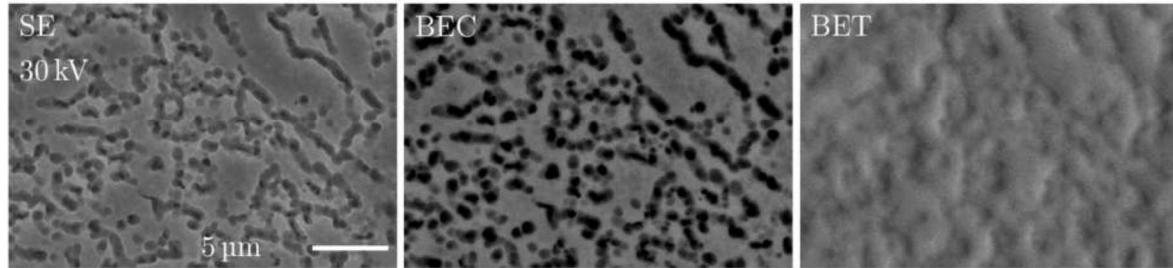
natural oxide



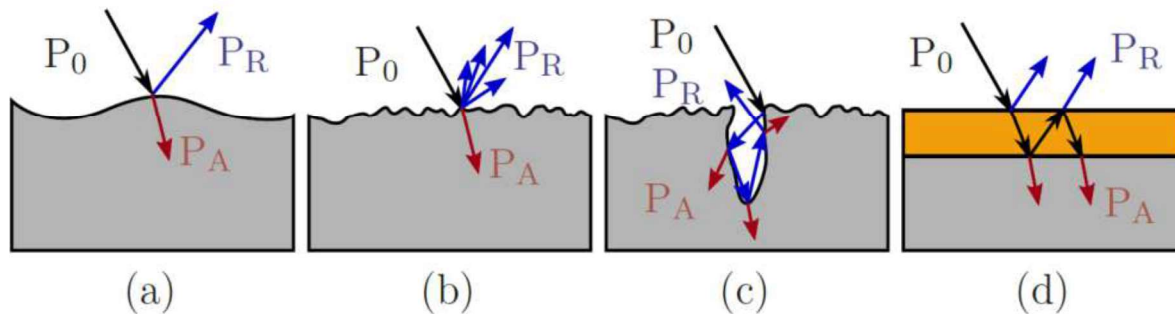
Different thin-film systems possible

	T_M / K	T_V / K	λ_F / W/(kg·K)	c_p / J/(kg·K)	H_f kJ/mol	H_v kJ/mol
Nb	2750	5014	54	260	26.8	694
Sn	505	2859	66.8	229	7.03	296.1

Initial state of the Nb₃Sn layers



	O Atom %	C Atom %	Sn Atom %
P ₁	5.65	13.7	21.38
P ₂	7.28	11.8	20.59
P ₃	8.05	15.78	22.49
P ₄	10.69	11.74	11.7
P ₅	6.54	16.56	13.33
P ₆	7.88	0.0	8.97
P ₇	7.52	38.22	9.86



Nb₃Sn:

- Nb_{1-β}Sn_β (approx. 0.18 < β < 0.25)
- Surface roughness must be in nm range
⇒ superconducting coherence length 4 nm

Sample:

- ⇒ Nb₃Sn on Cu from HZB
- ⇒ Produced via bronze route

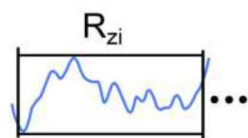
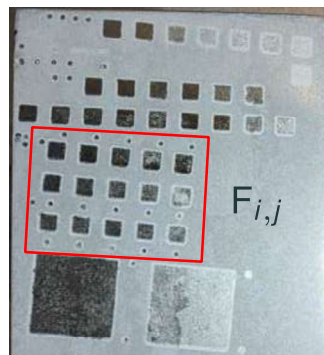
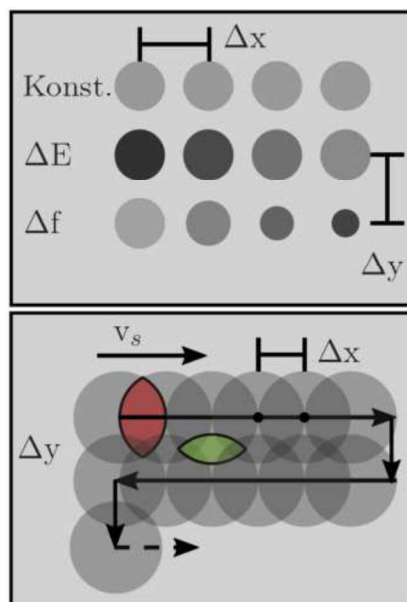
Initial state

- EDX measurement A=0.2 mm²:
⇒ Sn(min/max)=(5.4/20.8) atom / %, $\overline{\text{Sn}}=14.7 \pm 4.1$ atom / %
⇒ porous surface reason for fluctuating tin concentration

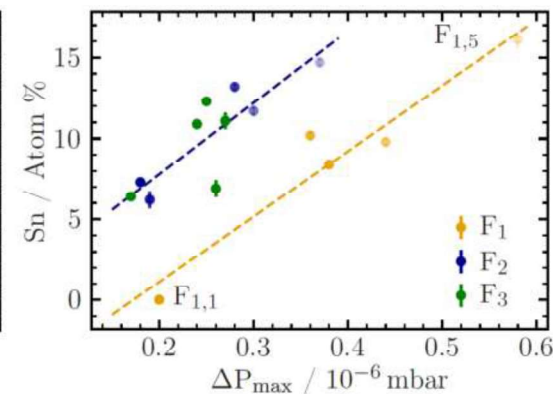
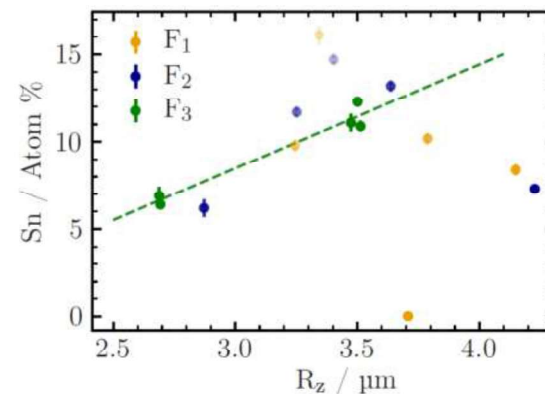
Laser material processing

Inhomogeneous composition and texture are problematic

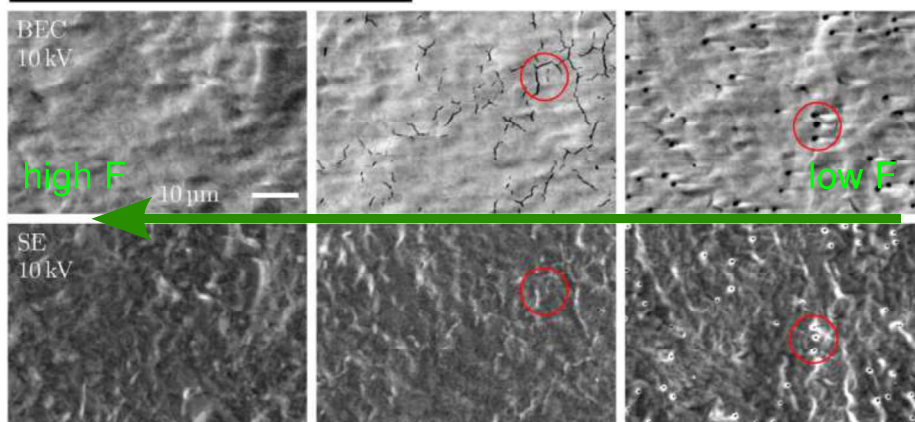
First results of Nb₃Sn laser polishing



R_z Sensitive to peaks



	konst.	Change	$F_{i,1}$	$F_{i,2}$	$F_{i,3}$	$F_{i,4}$	$F_{i,5}$
$F_{1,j}$	$\Delta f = 3.5 \text{ mm}$	$\Delta(x,y) / \mu\text{m}$	62.5	50	40	31.25	20
$F_{2,j}$		$\Delta(x,y) / \mu\text{m}$	62.5	50	40	31.25	20
		$\Delta f / \text{mm}$	4.5	5.5	6.5	7.5	8.5
$F_{3,j}$	$\Delta f = 6.5 \text{ mm}, \Delta(x,y) = 40 \mu\text{m}$	/					



$F_{1,5}$

$F_{2,1}$

$F_{2,4}$

Point and area measurements

⇒ Correlation Sn R_z

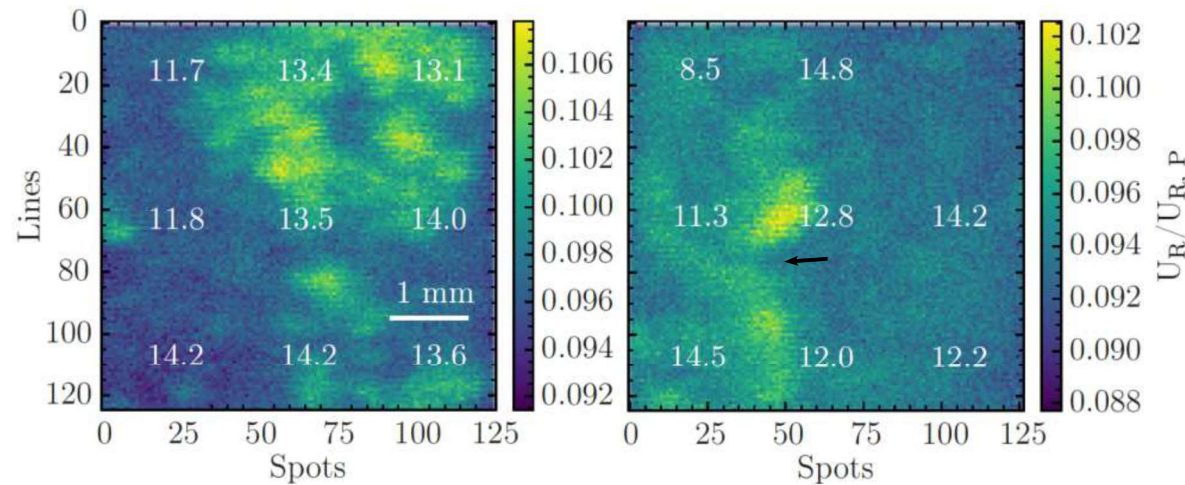
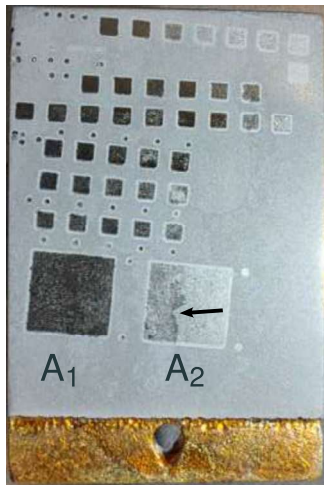
⇒ Correlation Sn ΔP

⇒ Higher Sn losses and R_z at higher

F and lower $\Delta(x, y)$

⇒ Surface artefacts at low F

First results of Nb₃Sn laser polishing



EDX measurement

Sn in atom %



Measurement at
different
locations

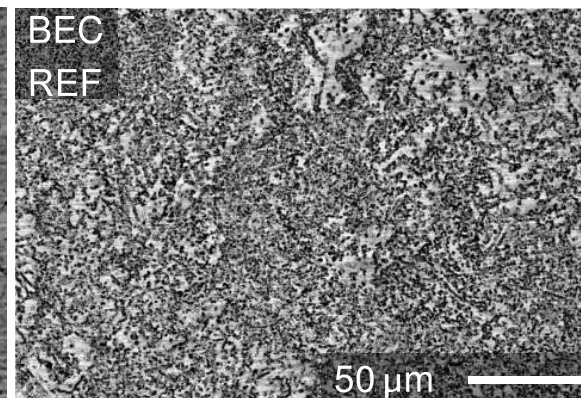
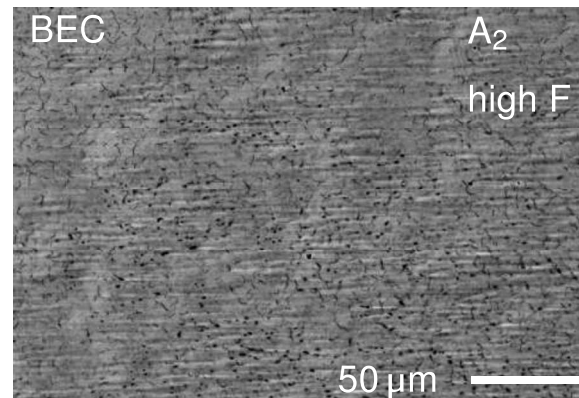
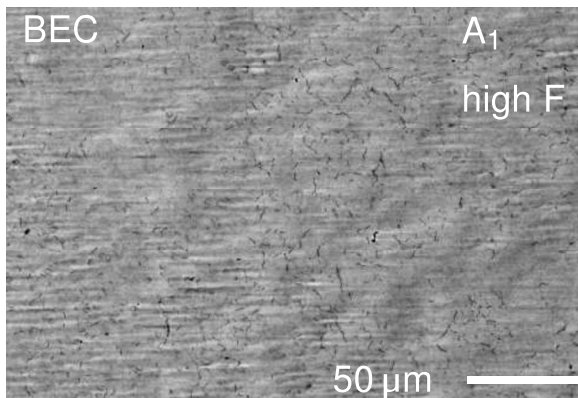
Constant laser parameters over the entire areas $F(A_1) > F(A_2)$

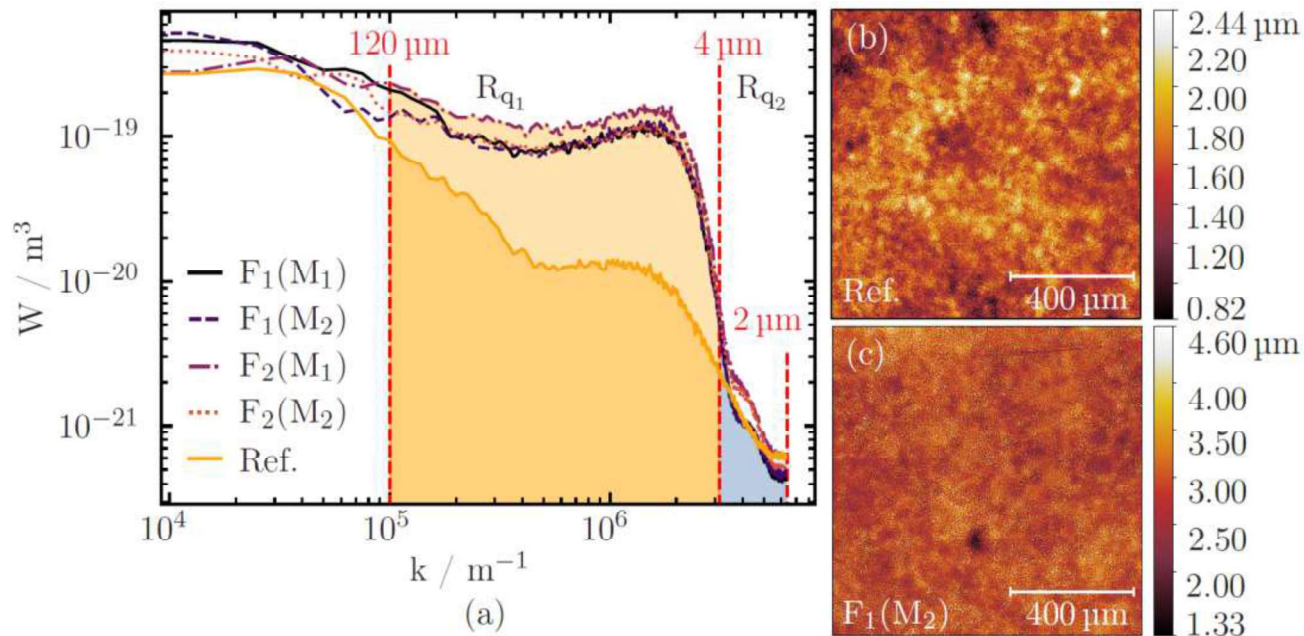
⇒ Differences in reflectivity

⇒ Change in reflectivity measurable in the reflected laser energy

⇒ Origin unclear

⇒ Further measurements necessary





PSDF analysis and calculation of R_q
in defined frequency range

$F(F_1) > F(F_2)$
 $\Rightarrow$ higher roughness with lower F
 $\Rightarrow$ Sn effect

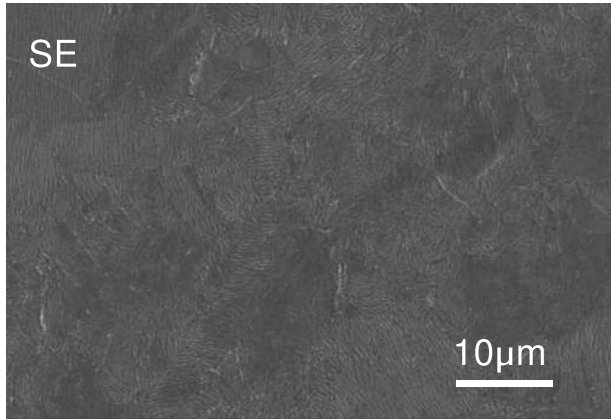
No wavy structures due to laser treatment

Roughness increased by laser treatment
in the entire frequency range
 $\Rightarrow$ No significant increase for low roughness

$\Rightarrow$ Decide on micro-roughness for
field emission

	$F_1(M_1)$	$F_1(M_2)$	$F_2(M_1)$	$F_2(M_2)$	Ref.
$R_{q1}(120 \mu m, 4 \mu m) / nm$	518	517	591	514	242
$R_{q1}(4 \mu m, 2 \mu m) / nm$	56	56	69	64	55

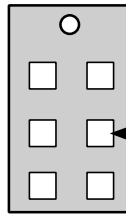
First results of Nb-thin film / Cu laser polishing



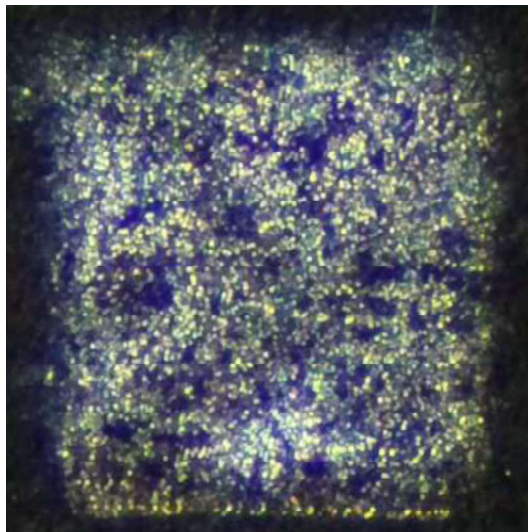
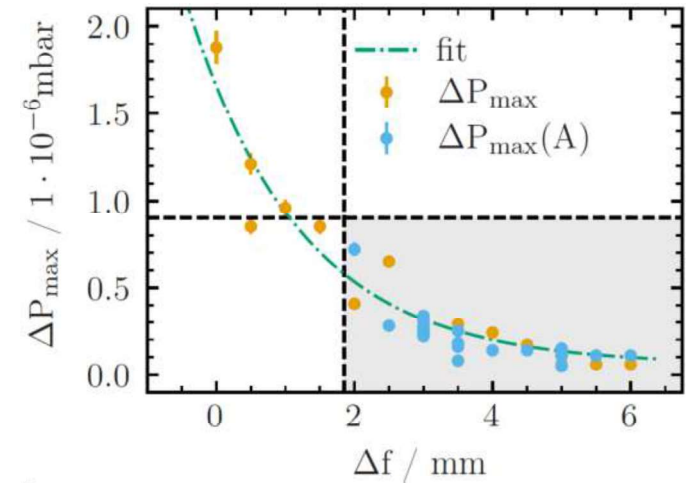
Characterize before laser polishing

$$R_z = 0.56 \pm 0.06 \mu\text{m}$$

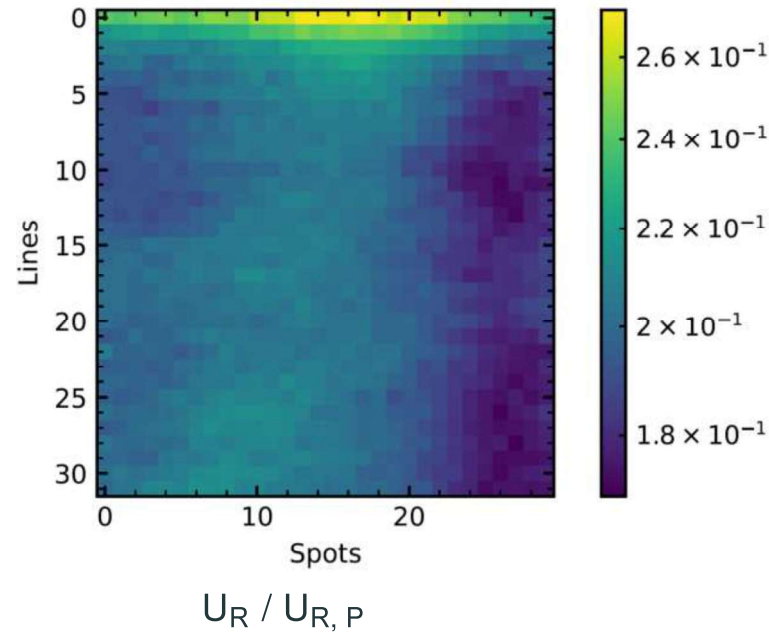
O Atom



First characterize
then laser



Optical microscope



Spot and area measurements
1x1mm² measurements with
change of polishing parameters

Goal:

Remelting + crystal growth

$$\Delta f = 3 \text{ mm}, \Delta x = \Delta y = 31.25 \mu\text{m}$$

⇒ Further analyses +

Nb₃Sn coating

Summary & Outlook

- Commissioning of the new hardware
 - ⇒ Beam profile camera, long-range microscope, beam attenuator
- Extension of the vacuum chamber to enable the beam diameter at the sample surface to be determined
- First investigations of Nb₃Sn layers on Cu
 - ⇒ porous surface, fluctuating Sn concentrations and very different material parameters are a challenge
- ⇒ Sn loss due to laser treatment and increase in roughness
- ⇒ Polishing of Nb₃Sn layers questionable but remelting, Crystal growth, homogenization possible
 1. **Idea:** Creation of layers with higher Sn concentrations to compensate Sn loss
 2. **Idea:** Polishing of Nb layers on Cu ⇒ then Nb₃Sn coating
 - ⇒ Prevention of porous coating
 - ⇒ First results but further investigations necessary

Thank you very much for listening!



Thanks for support by

HZB:
Cooperation
by Nb₃Sn

HZB Helmholtz
Zentrum Berlin

DESY:
Measurements
at Petra III and
extensive
cooperation

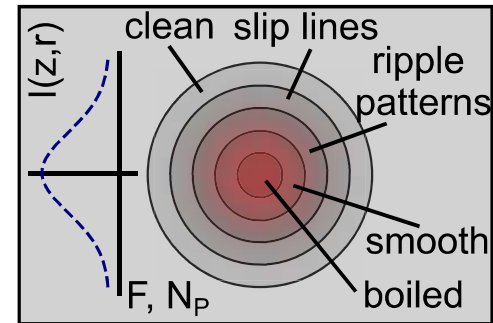
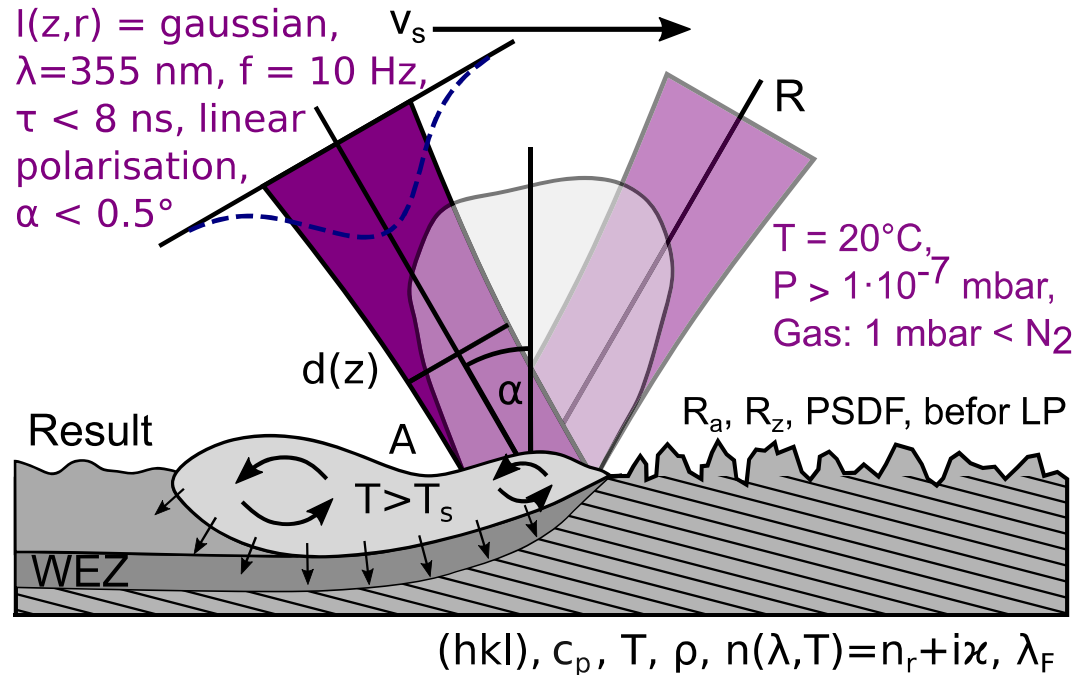


BMBF (BMFTR):
Financial Support by
the BMBF, projects no:
05H18PXR1 and
05H21PXR1 (ErUM Pro)



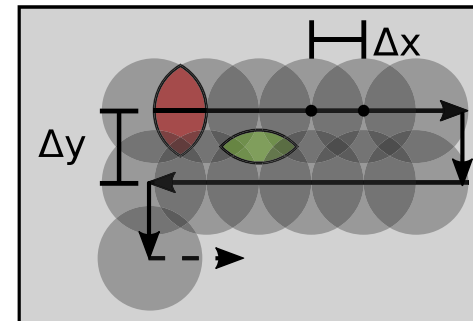
Bundesministerium
für Forschung, Technologie
und Raumfahrt

Questions?



Point measurements

- Investigation of the influence of F, N_p , pressure, surface defects, ...

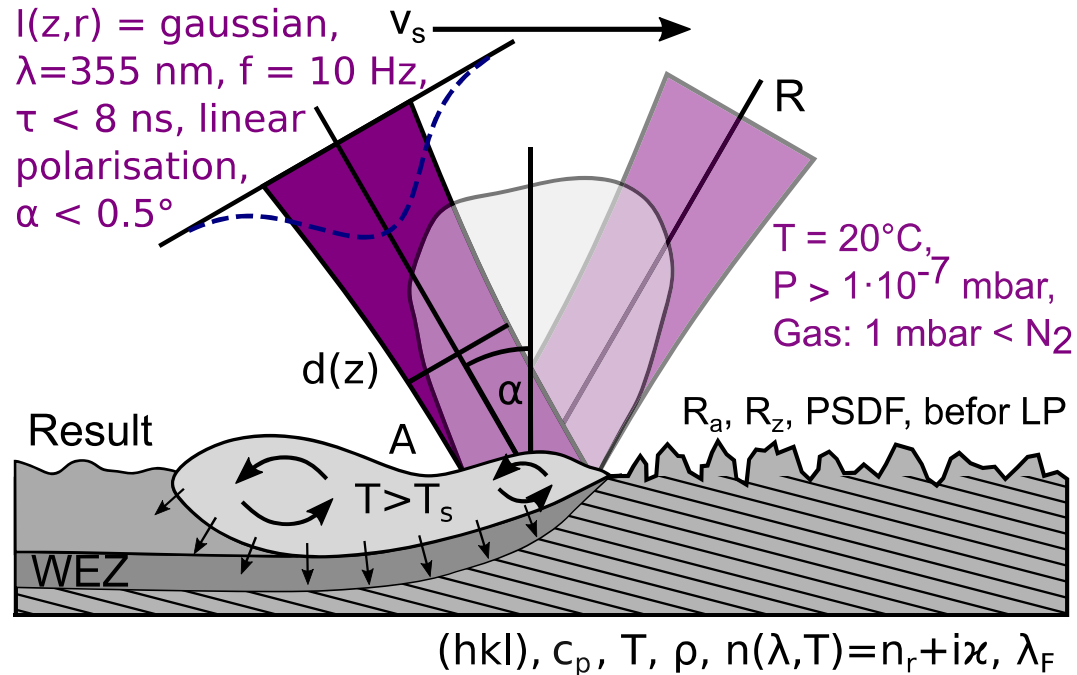


Area measurements

- Investigation of the influence of the overlap of the spots and the rows, ...

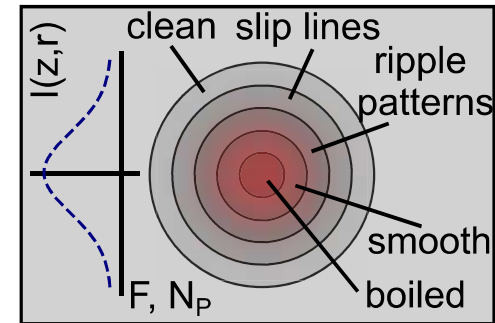
- The result of the LMB is influenced by many parameters:
 - **Laser:** λ, τ, f , polarization
 - **Process:** $\alpha, \Delta x, \Delta y, v_s, N_p$, atmosphere/vacuum, ...
 - **Sample:** material, roughness, grain size and orientation

⇒ Highly complex optimization problem



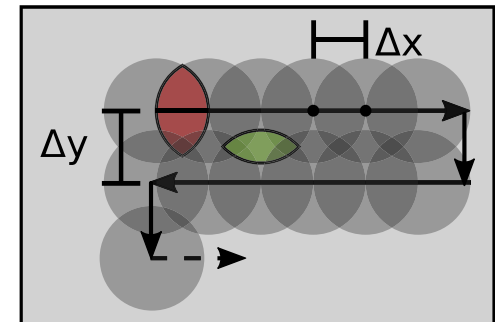
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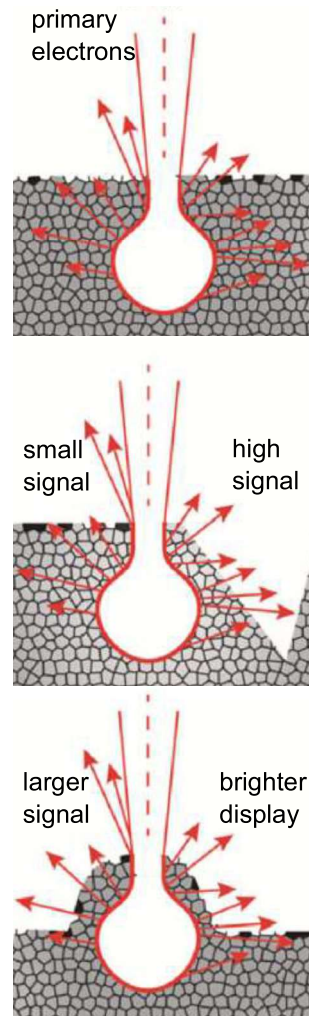
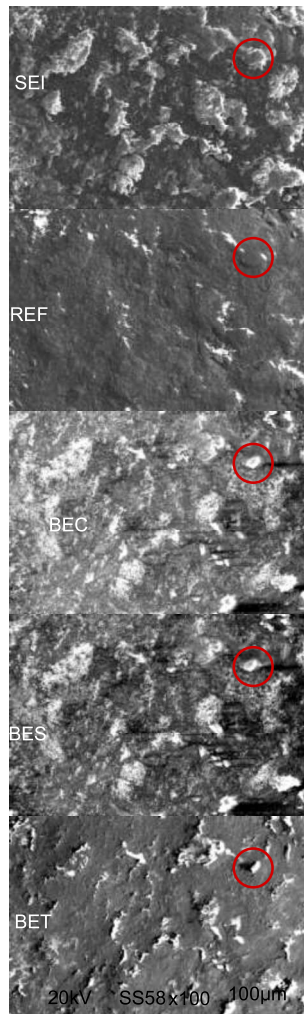
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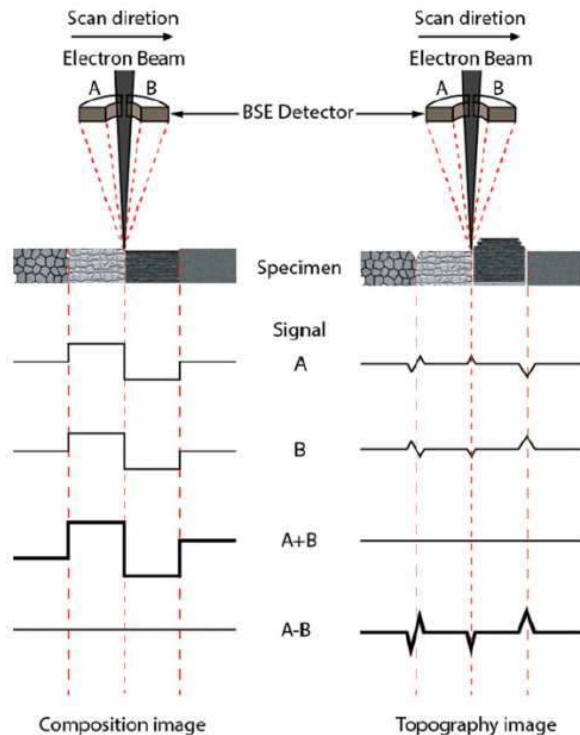
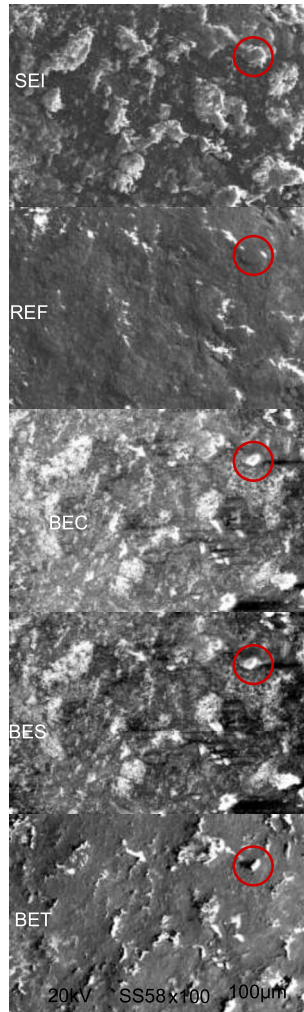
- Carrying out point and area measurements

⇒ Change Δx , Δy , ΔF

⇒ Examination of the results by SEM/EDX/OP/XRD



- **SEI - Secondary electrons:** Contrast due to the topography of the surface
- **REF - Reflect electrons:**
- **BE - Backscattered Electron:** Contrast by compositional or atomic number (Z), two elements $\Rightarrow$ heavy elements are displayed lighter than lighter ones
 - **BEC - COMPO mode** Signal = sum of both detector halves (A + B), Differences in the composition (Z-contrast) of the sample become visible
 - **BES - SHADOW mode** Combined signal from two detectors, first detector above the sample as in COMPO mode, second detector at an oblique angle $\Rightarrow$ Combination of both signals leads to shadowing effects $\Rightarrow$ 3-dimensional morphology and topography of the surface features of the surface become visible
 - **BET Backscatter Electron Topo:** Highlight surface topography $\Rightarrow$ Signal is the difference between the detector halves (A-B)



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Laser control

OPEN CLOSE Status

Pump Current (A) 119.9 FF - 1064nm

Bunch Size 0.0 SH - 532nm

Rate Divisor 0.0 TH - 355nm

Bunch Mode ☐ Count 4523180 Cavity Temp 29.5

Pump control

Serial Connection COM11

Disconnect Disconnect Connect Data

Pump Data

Leistung	5	W
Frequenz	1100	Hz
Umdr.	66000	rpm
Druck	4.3E-06	mbar

Gasart NC
Status Normal
Active Stop False
Soft Start False

Logging

Boot Laser
Laser offline. Try again in 5s.
Arduino Connect
Connect to pump
Laser connected and set to default values!
Values of the new sample are saved

Polish settings

Move Polish Pump Measurements

NewSample Name Ordner Probe354

Material Copper D/mm 20

☐ Circle ☐ Rect Draw Sample

Name Name Ordner der Messung45

Modus line 1 Cal. Time

DL 140 μ m % 90

T: 800 μ s x speed

Local x 500 y 500

Start x 500 y 500

x 200 Δ x 0

y 200 Δ y 1

Spot 0 Spot line 0

Δ Lens 0 Lens z 0

N min 1 Δ N 0

lp 0 λ

Δ lp 5

Save NEIN

t Mess 2000 ms t Offset 1000 ms

Polish Draw Polish

Sample Plan

Polish plan

Position laser: 500 500

Resolution axe: x: 1 μ m | y: 65 μ m | z: 1 μ m

	not polish	in process	polish
area	☒		
Δ focus			
Δ lp			
spot			
pres.			

Pressure

Pressure / mbar (10^{-6})

Time / s (10^{-12})

Microscope

Cam

Stop Foto

Zeitfestlegen

Mikro Stepping 1/10

Steigung 2 mm

Pulsrate 10 Hz

Schritte 200

d(Spot) 140 μ m

Überlapp 90 %

E per puls 100 mJ

time per Step 0 μ s

time per mm.2 0 s

distance 0 μ m

F 0 J/cm²

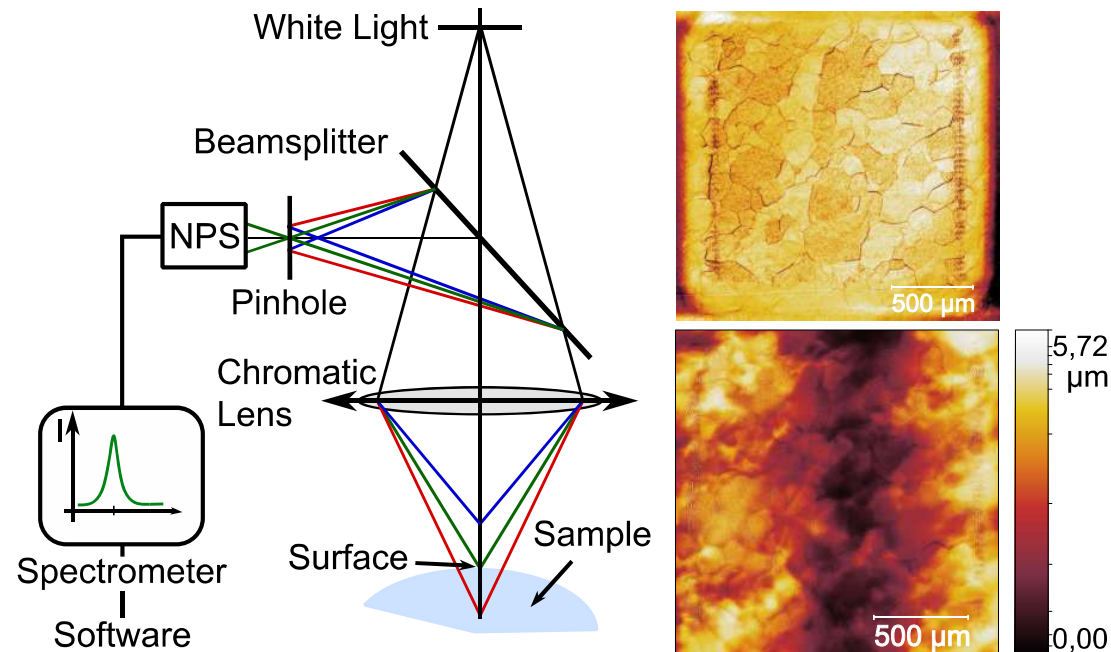
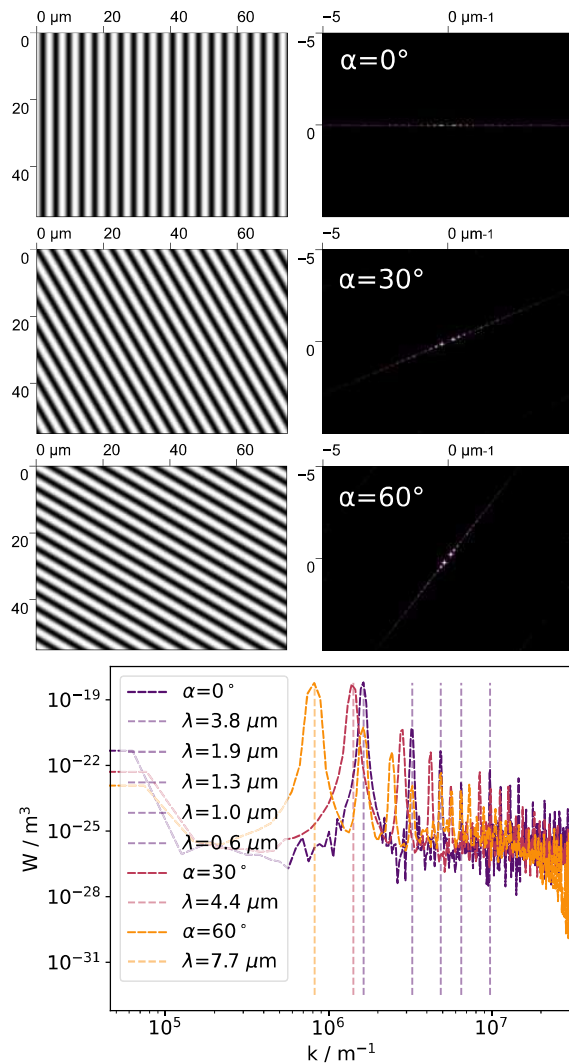
calculate

Set New XSpeed

Speed settings

New laser software

- Control of the new pumping station (**oil-free**)
- Stepper motors are controlled via an Arduino so that the **motor speeds** can be **changed**
- ➔ **30 % faster** polishing speed, 10 min/mm, limit f=10Hz
- visualisation of the polished areas



- $PSDF(\omega) = PSDF(-\omega) = \int_{-\infty}^{\infty} R(\tau_A) \exp(-i\omega\tau_A) d\tau_A$

- $R_q^2(k_{\min}, k_{\max}) = \int_{k_{\min}}^{k_{\max}} PSDF dk$

- $F(k, l) = \sum_{n=0}^{N-1} \sum_{j=0}^{N-1} f(n, j) \exp \left[-2\pi i \left(\frac{kn + lj}{N} \right) \right]$

⇒ Characterization of the surface by optical profilometry + PSDF + 2d FFT calculation